

# 74LVT2244

3.3 V octal buffer/line driver with 30  $\Omega$  termination resistors;  
3-state

Rev. 4 — 17 May 2021

Product data sheet

## 1. General description

The 74LVT2244 is an 8-bit buffer/line driver with 3-state outputs. The device can be used as two 4-bit buffers or one 8-bit buffer. The device features two output enables (1 $\overline{OE}$  and 2 $\overline{OE}$ ), each controlling four of the 3-state outputs. A HIGH on n $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs

The 74LVT2244 is designed with 30  $\Omega$  series resistance in both the HIGH and LOW states of the output. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus receivers/transmitters.

## 2. Features and benefits

- Octal bus interface
- 3-state buffers
- Wide supply voltage range from 2.7 to 3.6 V
- Overvoltage tolerant inputs to 5.5 V
- BiCMOS high speed and output drive
- Output capability: +12 mA and -12 mA
- Direct interface with TTL levels
- No bus current loading when output is tied to 5 V bus
- Bus hold on data inputs
- Power-up 3-state
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Live insertion and extraction permitted
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V

## 3. Ordering information

Table 1. Ordering information

| Type number | Package           |         |  |          |
|-------------|-------------------|---------|--|----------|
|             | Temperature range | Name    | Description  | Version  |
| 74LVT2244D  | -40 °C to +85 °C  | SO20    | plastic small outline package; 20 leads; body width 7.5 mm             | SOT163-1 |
| 74LVT2244PW | -40 °C to +85 °C  | TSSOP20 | plastic thin shrink small outline package; 20 leads; body width 4.4 mm | SOT360-1 |

### 4. Functional diagram

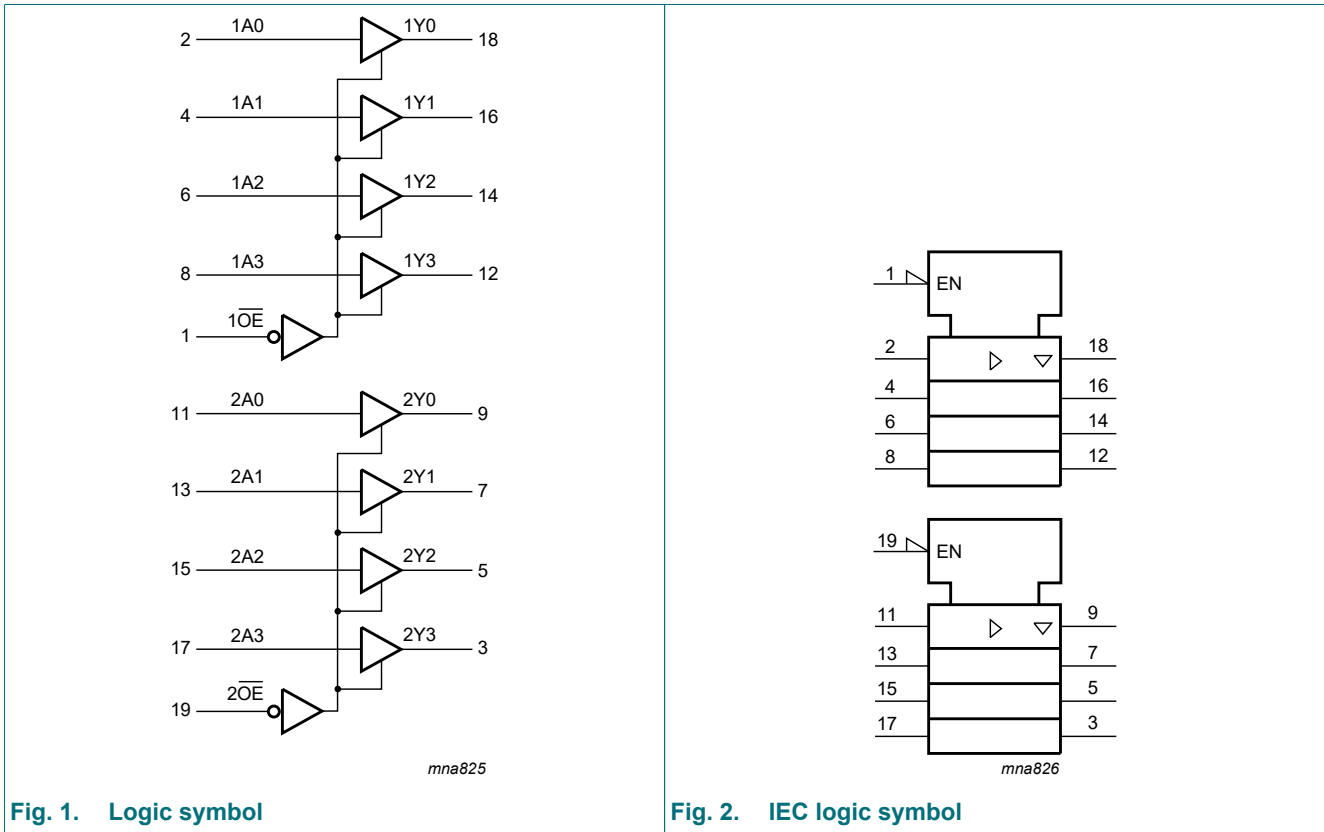


Fig. 1. Logic symbol

Fig. 2. IEC logic symbol

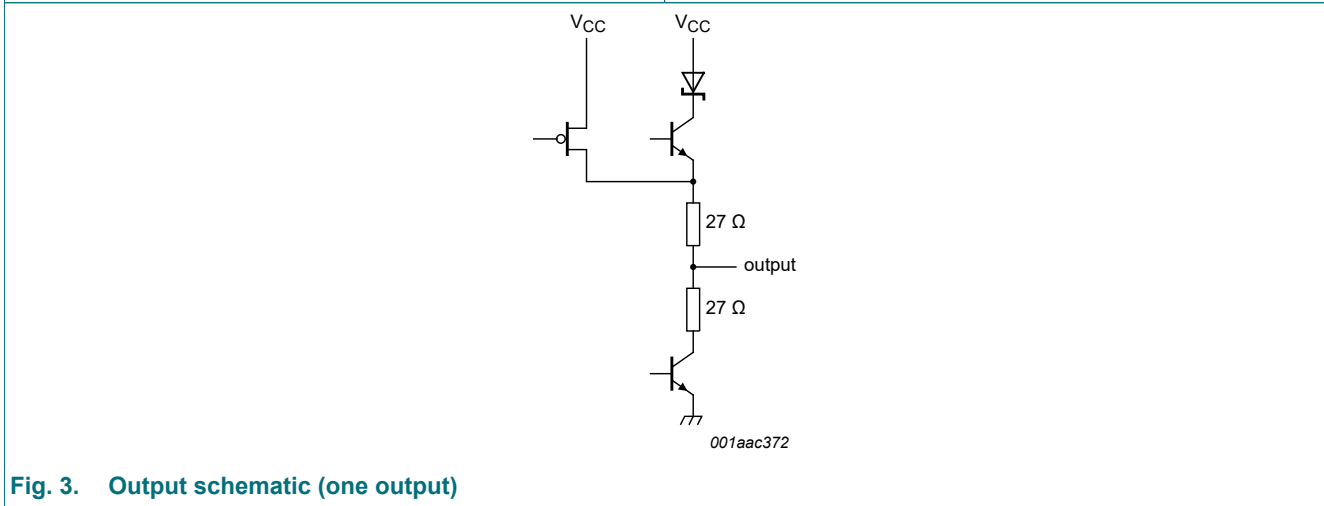


Fig. 3. Output schematic (one output)

## 5. Pinning information

### 5.1. Pinning

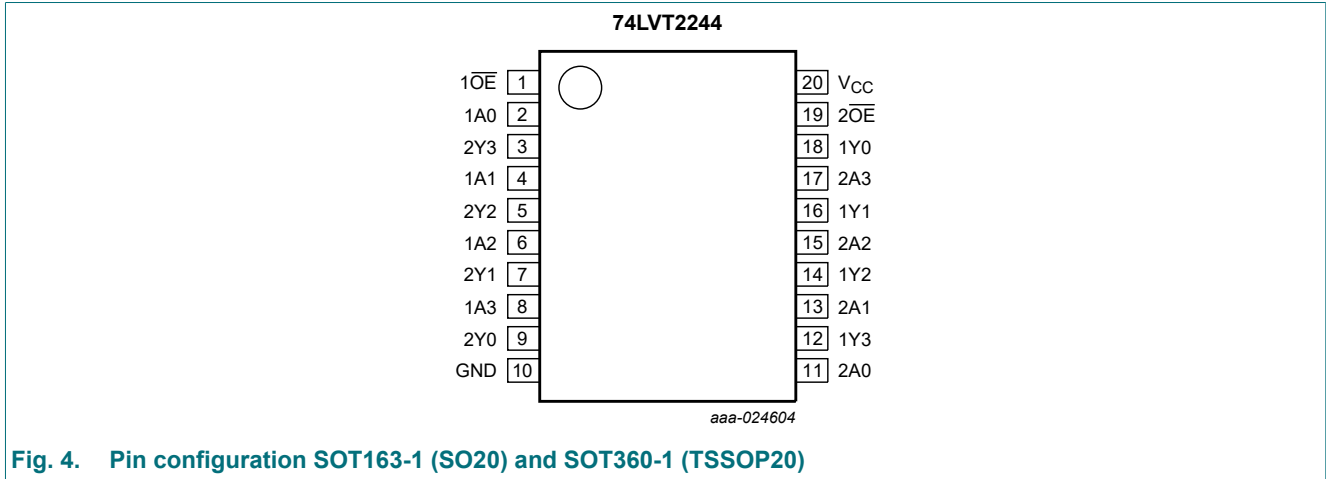


Fig. 4. Pin configuration SOT163-1 (SO20) and SOT360-1 (TSSOP20)

### 5.2. Pin description

Table 2. Pin description

| Symbol              | Pin            | Description                      |
|---------------------|----------------|----------------------------------|
| 1OE, 2OE            | 1, 19          | output enable input (active low) |
| 1A0, 1A1, 1A2, 1A3  | 2, 4, 6, 8     | data input                       |
| 2Y0, 2Y1, 2Y2, 2Y3  | 9, 7, 5, 3     | data output                      |
| GND                 | 10             | ground (0 V)                     |
| 2A0, 2A1, 2A2, 2A3  | 11, 13, 15, 17 | data input                       |
| 1Y0, 1Y1, 1Y2, 1Y3, | 18, 16, 14, 12 | data output                      |
| V <sub>CC</sub>     | 20             | supply voltage                   |

## 6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

| Control | Input | Output |
|---------|-------|--------|
| nOE     | nAn   | nYn    |
| L       | L     | L      |
| L       | H     | H      |
| H       | X     | Z      |

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                            | Min  | Max  | Unit         |
|-----------|-------------------------|---------------------------------------|------|------|--------------|
| $V_{CC}$  | supply voltage          |                                       | -0.5 | +4.6 | V            |
| $V_I$     | input voltage           | [1]                                   | -0.5 | +7.0 | V            |
| $V_O$     | output voltage          | output in OFF-state or HIGH-state [1] | -0.5 | +7.0 | V            |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                           | -50  | -    | mA           |
| $I_{OK}$  | output clamping current | $V_O < 0$ V                           | -50  | -    | mA           |
| $I_O$     | output current          | output in LOW-state                   | -    | 128  | mA           |
|           |                         | output in HIGH-state                  | -64  | -    | mA           |
| $T_{stg}$ | storage temperature     |                                       | -65  | +150 | $^{\circ}$ C |
| $T_j$     | junction temperature    | [2]                                   | -    | +150 | $^{\circ}$ C |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ to $+85$ $^{\circ}$ C |      | 500  | mW           |

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150  $^{\circ}$ C.

## 8. Recommended operating conditions

**Table 5. Operating conditions**

| Symbol              | Parameter                           | Conditions      | Min | Typ | Max | Unit         |
|---------------------|-------------------------------------|-----------------|-----|-----|-----|--------------|
| $V_{CC}$            | supply voltage                      |                 | 2.7 | -   | 3.6 | V            |
| $V_I$               | input voltage                       |                 | 0   | -   | 5.5 | V            |
| $I_{OH}$            | HIGH-level output current           |                 | -   | -   | -12 | mA           |
| $I_{OL}$            | LOW-level output current            |                 | -   | -   | 12  | mA           |
| $T_{amb}$           | ambient temperature                 | in free-air     | -40 | -   | +85 | $^{\circ}$ C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | outputs enabled | -   | -   | 10  | ns/V         |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                | Parameter                          | Conditions   | T <sub>amb</sub> = -40 °C to +85 °C |         |      | Unit |
|-----------------------|------------------------------------|--|-------------------------------------|---------|------|------|
|                       |                                    |  | Min                                 | Typ [1] | Max  |      |
| V <sub>IK</sub>       | input clamping voltage             | V <sub>CC</sub> = 2.7 V; I <sub>IK</sub> = -18 mA  | -1.2                                | -0.9    | -    | V    |
| V <sub>IH</sub>       | HIGH-level input voltage           |  | 2.0                                 | -       | -    | V    |
| V <sub>IL</sub>       | LOW-level input voltage            |  | -                                   | -       | 0.8  | V    |
| V <sub>OH</sub>       | HIGH-level output voltage          | V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -12 mA  | 2.0                                 | 2.5     | -    | V    |
| V <sub>OL</sub>       | LOW-level output voltage           | V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 12 mA   | -                                   | -       | 0.8  | V    |
| I <sub>I</sub>        | input leakage current              | all input pins   |                                     |         |      |      |
|                       |                                    | V <sub>CC</sub> = 0 V or 3.6 V; V <sub>I</sub> = 5.5 V   | -                                   | 1       | 10   | μA   |
|                       |                                    | control pins   |                                     |         |      |      |
|                       |                                    | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND   | -                                   | ±0.1    | ±1   | μA   |
|                       |                                    | data pins [2]  |                                     |         |      |      |
|                       |                                    | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub><br>V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 0 V                                 | -                                   | 0.1     | 1    | μA   |
| I <sub>OFF</sub>      | power-off leakage current          | V <sub>CC</sub> = 0 V; V <sub>I</sub> or V <sub>O</sub> = 0 V to 4.5 V   | -                                   | 1       | ±100 | μA   |
| I <sub>BHL</sub>      | bus hold LOW current               | V <sub>CC</sub> = 3 V; V <sub>I</sub> = 0.8 V [3]  | 75                                  | 150     | -    | μA   |
| I <sub>BHH</sub>      | bus hold HIGH current              | V <sub>CC</sub> = 3 V; V <sub>I</sub> = 2.0 V  | -                                   | -150    | -75  | μA   |
| I <sub>BHLO</sub>     | bus hold LOW overdrive current     | nAn input; V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = 3.6 V  | 500                                 | -       | -    | μA   |
| I <sub>BHHO</sub>     | bus hold HIGH overdrive current    | nAn input; V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = 3.6 V  | -                                   | -       | -500 | μA   |
| I <sub>EX</sub>       | external current                   | nYn output in HIGH-state when V <sub>O</sub> > V <sub>CC</sub> ;<br>V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 3.0 V                        | -                                   | 60      | 125  | μA   |
| I <sub>O(pu/pd)</sub> | power-up/power-down output current | V <sub>CC</sub> ≤ 1.2 V; V <sub>O</sub> = 0.5 V to V <sub>CC</sub> ;<br>V <sub>I</sub> = GND or V <sub>CC</sub> ; nOE = don't care [4]     | -                                   | ±1      | ±100 | μA   |
| I <sub>OZ</sub>       | OFF-state output current           | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>   |                                     |         |      |      |
|                       |                                    | V <sub>O</sub> = 3.0 V   | -                                   | 1       | 5    | μA   |
|                       |                                    | V <sub>O</sub> = 0.5 V   | -5                                  | -1      | -    | μA   |
| I <sub>CC</sub>       | supply current                     | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = GND or V <sub>CC</sub> ; I <sub>O</sub> = 0 A  |                                     |         |      |      |
|                       |                                    | output HIGH  | -                                   | 0.12    | 0.19 | mA   |
|                       |                                    | output LOW   | -                                   | 3       | 12   | mA   |
|                       |                                    | outputs disabled [5]   | -                                   | 0.12    | 0.19 | mA   |
| ΔI <sub>CC</sub>      | additional supply current          | per input pin; V <sub>CC</sub> = 3.0 V to 3.6 V;<br>one input at V <sub>CC</sub> - 0.6 V and<br>other inputs at V <sub>CC</sub> or GND [6] | -                                   | 0.1     | 0.2  | mA   |
| C <sub>I</sub>        | input capacitance                  | V <sub>I</sub> = 0 V or 3.0 V  | -                                   | 4       | -    | pF   |
| C <sub>O</sub>        | output capacitance                 | outputs disabled; V <sub>O</sub> = 0 V or 3.0 V  | -                                   | 7       | -    | pF   |

[1] All typical values are at T<sub>amb</sub> = 25 °C.

[2] Unused pins at V<sub>CC</sub> or GND.

[3] This is the bus hold overdrive current required to force the input to the opposite logic state.

[4] This parameter is valid for any V<sub>CC</sub> between 0 V and 1.2 V with a transition time of up to 10 ms. From V<sub>CC</sub> = 1.2 V to V<sub>CC</sub> = 3.3 V ± 0.3 V a transition time of 100 μs is permitted. This parameter is valid for T<sub>amb</sub> = 25 °C only.

[5] I<sub>CC</sub> is measured with outputs pulled to V<sub>CC</sub> or GND.

[6] This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND.

## 10. Dynamic characteristics

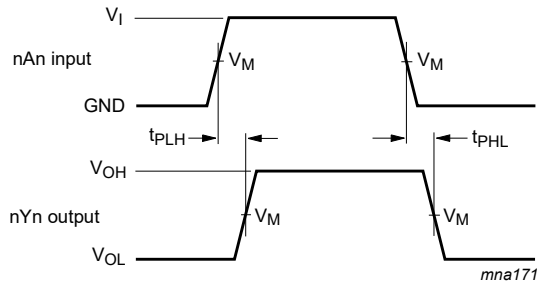
**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7.

| Symbol           | Parameter                           | Conditions                           | T <sub>amb</sub> = -40 °C to +85 °C |         |     | Unit |
|------------------|-------------------------------------|--------------------------------------|-------------------------------------|---------|-----|------|
|                  |                                     |                                      | Min                                 | Typ [1] | Max |      |
| t <sub>PLH</sub> | LOW to HIGH propagation delay       | nAn to nYn; see Fig. 5               |                                     |         |     |      |
|                  |                                     | V <sub>CC</sub> = 2.7 V              | -                                   | -       | 5.3 | ns   |
|                  |                                     | V <sub>CC</sub> = 3.0 V to 3.6 V     | 1                                   | 2.9     | 4.4 | ns   |
| t <sub>PHL</sub> | HIGH to LOW propagation delay       | nAn to nYn; see Fig. 5               |                                     |         |     |      |
|                  |                                     | V <sub>CC</sub> = 2.7 V              | -                                   | -       | 4.4 | ns   |
|                  |                                     | V <sub>CC</sub> = 3.0 V to 3.6 V     | 1                                   | 2.9     | 4.1 | ns   |
| t <sub>PZH</sub> | OFF-state to HIGH propagation delay | n $\overline{O}E$ to nYn; see Fig. 6 |                                     |         |     |      |
|                  |                                     | V <sub>CC</sub> = 2.7 V              | -                                   | -       | 7.7 | ns   |
|                  |                                     | V <sub>CC</sub> = 3.0 V to 3.6 V     | 1                                   | 3.7     | 5.9 | ns   |
| t <sub>PZL</sub> | OFF-state to LOW propagation delay  | n $\overline{O}E$ to nYn; see Fig. 6 |                                     |         |     |      |
|                  |                                     | V <sub>CC</sub> = 2.7 V              | -                                   | -       | 6.2 | ns   |
|                  |                                     | V <sub>CC</sub> = 3.0 V to 3.6 V     | 1.1                                 | 3.7     | 5.5 | ns   |
| t <sub>PHZ</sub> | HIGH to OFF-state propagation delay | n $\overline{O}E$ to nYn; see Fig. 6 |                                     |         |     |      |
|                  |                                     | V <sub>CC</sub> = 2.7 V              | -                                   | -       | 6.8 | ns   |
|                  |                                     | V <sub>CC</sub> = 3.0 V to 3.6 V     | 1.9                                 | 4.3     | 6.1 | ns   |
| t <sub>PLZ</sub> | LOW to OFF-state propagation delay  | n $\overline{O}E$ to nYn; see Fig. 6 |                                     |         |     |      |
|                  |                                     | V <sub>CC</sub> = 2.7 V              | -                                   | -       | 4.5 | ns   |
|                  |                                     | V <sub>CC</sub> = 3.0 V to 3.6 V     | 1.8                                 | 3.3     | 4.5 | ns   |

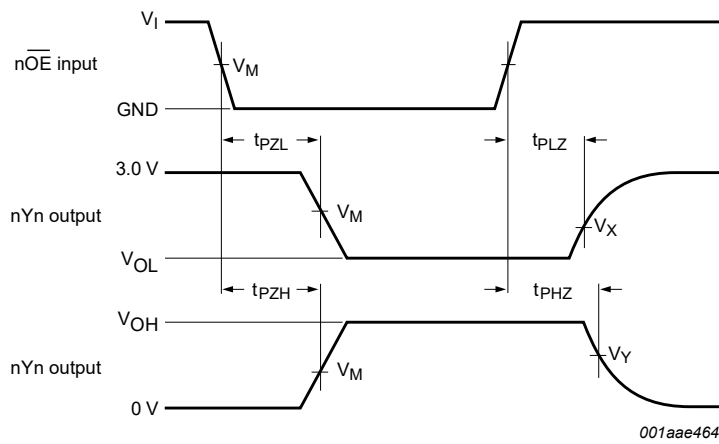
[1] All typical values are at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.

10.1. Waveforms and test circuit



Measurement points are given in [Table 8](#).  
 VOL and VOH are typical voltage output levels that occur with the output load.

Fig. 5. Propagation delay input (nAn) to output (nYn) propagation delays



Measurement points are given in [Table 8](#).  
 VOL and VOH are typical voltage output levels that occur with the output load.

Fig. 6. 3-state output enable and disable times

Table 8. Measurement points

| Input | Output |             |             |
|-------|--------|-------------|-------------|
| VM    | VM     | VX          | VY          |
| 1.5 V | 1.5 V  | VOL + 0.3 V | VOH - 0.3 V |

3.3 V octal buffer/line driver with 30 Ω termination resistors; 3-state

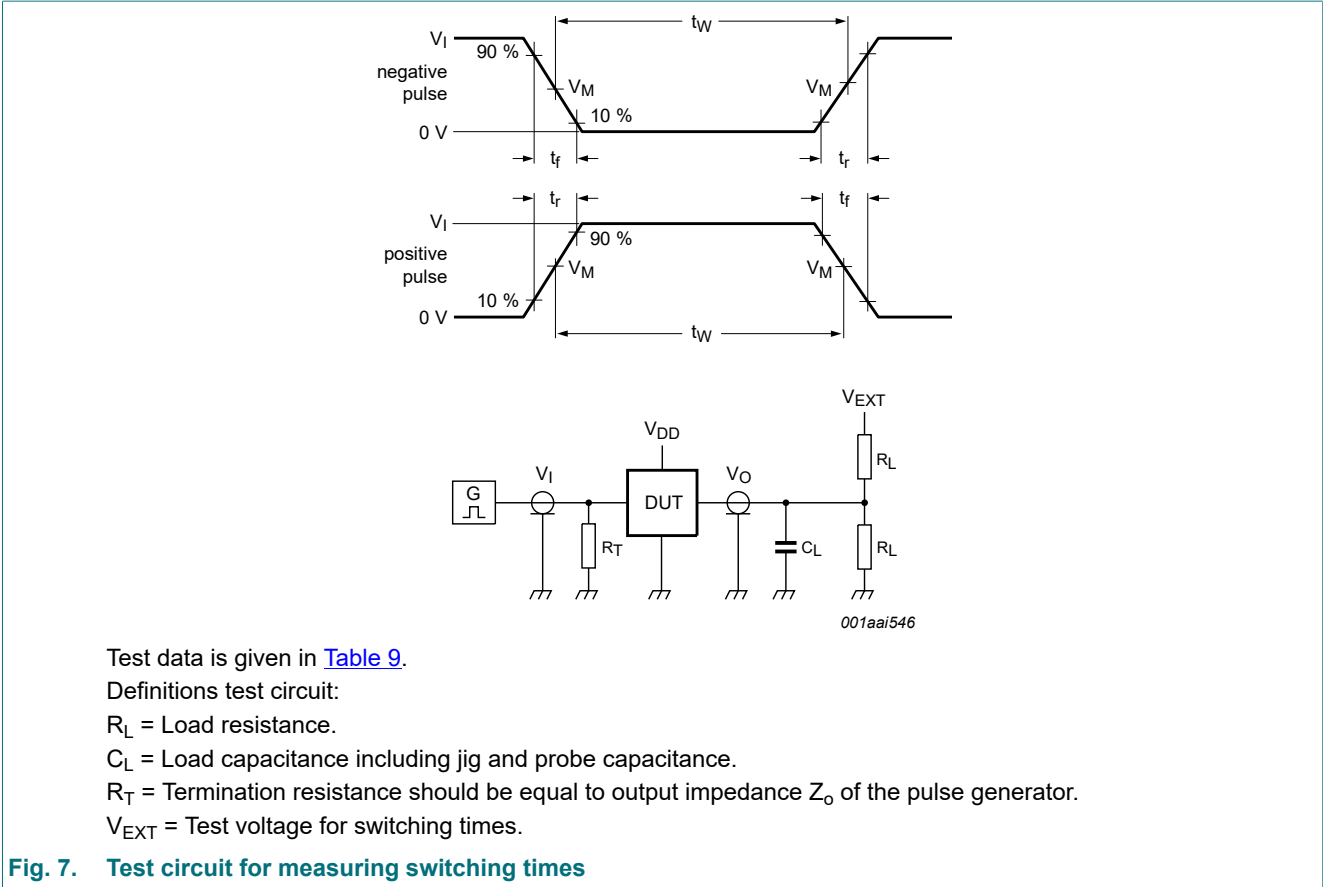


Table 9. Test data

| Input |               |        |               | Load  |       | $V_{EXT}$          |                    |                    |
|-------|---------------|--------|---------------|-------|-------|--------------------|--------------------|--------------------|
| $V_I$ | $f_i$         | $t_W$  | $t_r, t_f$    | $C_L$ | $R_L$ | $t_{PHZ}, t_{PZH}$ | $t_{PLZ}, t_{PZL}$ | $t_{PLH}, t_{PHL}$ |
| 2.7 V | $\leq 10$ MHz | 500 ns | $\leq 2.5$ ns | 50 pF | 500 Ω | GND                | 6 V                | open               |



11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



Fig. 8. Package outline SOT163-1 (SO20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

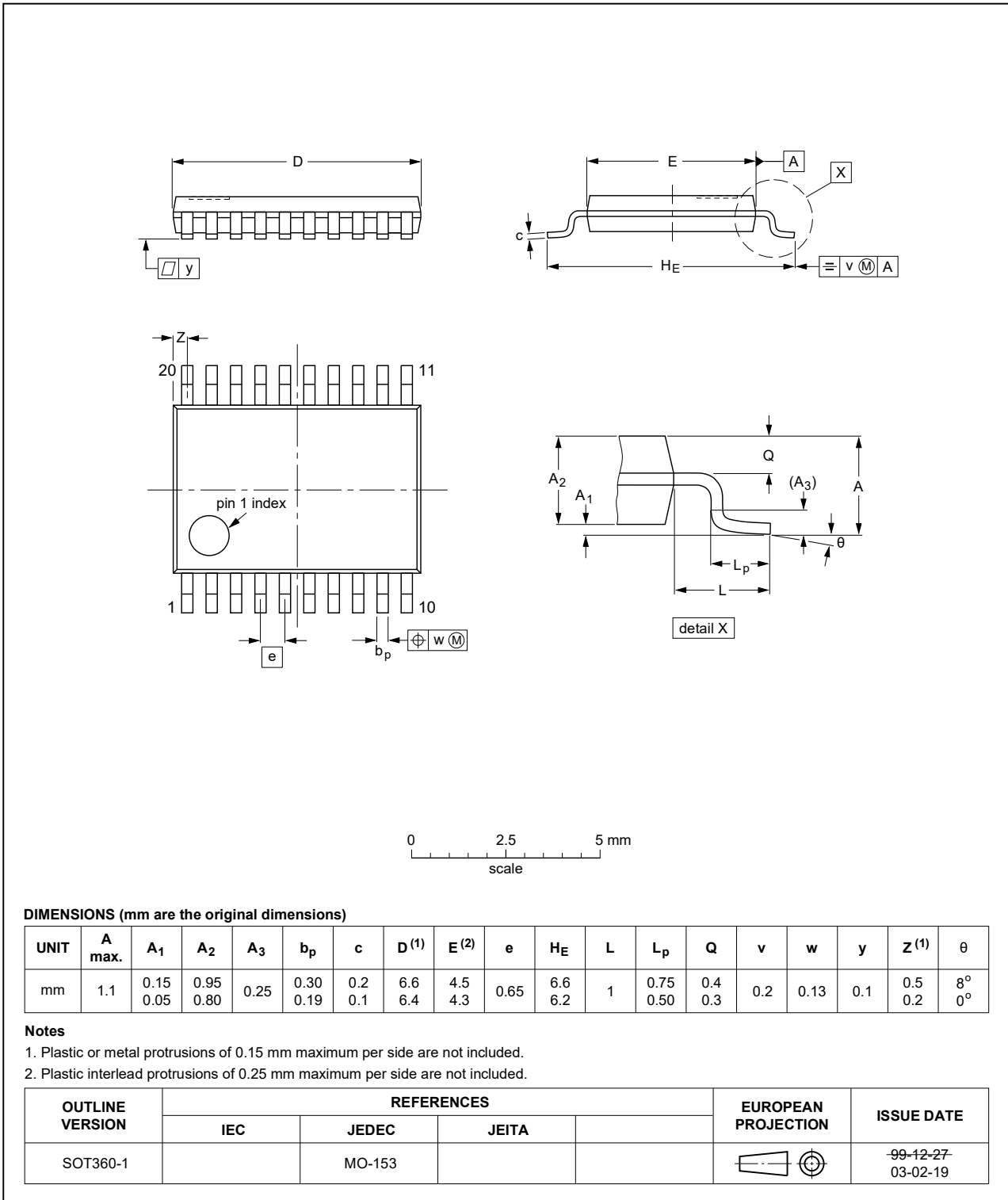


Fig. 9. Package outline SOT360-1 (TSSOP20)

## 12. Abbreviations

Table 10. Abbreviations

| Acronym | Description                                      |
|---------|--|
| BiCMOS  | Bi-polar Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                                |
| ESD     | ElectroStatic Discharge                          |
| HBM     | Human Body Model                                 |
| MM      | Machine Model                                    |
| TTL     | Transistor-Transistor Logic                      |

## 13. Revision history

Table 11. Revision history

| Document ID    | Release date   | Data sheet status     | Change notice | Supersedes    |
|----------------|--|-----------------------|---------------|---------------|
| 74LVT2244 v.4  | 20210517   | Product data sheet    | -             | 74LVT2244 v.3 |
| Modifications: | <ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type number 74LVT2244DB (SOT339-1 / SSOP20) removed.</li> <li><a href="#">Section 1</a> and <a href="#">Section 2</a> updated.</li> <li><a href="#">Section 7</a>: Derating values for <math>P_{tot}</math> total power dissipation removed (errata).</li> </ul> |                       |               |               |
| 74LVT2244 v.3  | 20160901   | Product data sheet    | -             | 74LVT2244 v.2 |
| Modifications: | <ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>  |                       |               |               |
| 74LVT2244 v.2  | 19980219   | Product specification | -             | 74LVT2244 v.1 |
| 74LVT2244 v.1  | 19960828   | Product specification | -             | -             |

## 14. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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